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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MA5J002E

Silicon epitaxial planar type

For high speed switching circuits

■ Features

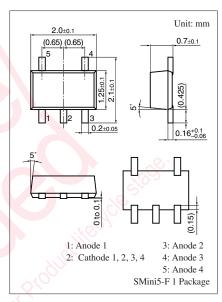
- Includes 4 elements of cathode common connection
- Parts reduction is possible
- Ideal for surge voltage absorption

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	80	V
Maximum peak reverse voltage	V_{RM}	80	V
Forward current *1	I_{F}	100	mA
Peak forward current *1	I_{FM}	225	mA
Non-repetitive peak forward surge current *1, 2	I_{FSM}	500	mA
Junction temperature	T_{j}	150	°C
Operating ambient temperature	T_{opr}	-25 to +105	°C
Storage temperature	T_{stg}	-55 to +150	°C O

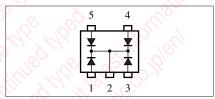
Note) *1: Value in single diode used.

$$*2: t = 1 s$$



Marking Symbol: M5B

Internal Connection

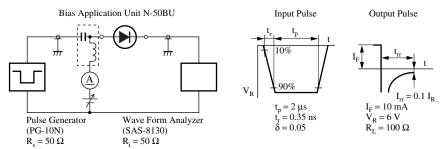


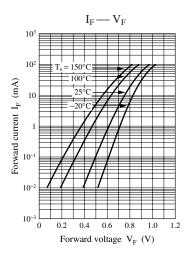
■ Electrical Characteristics T_a = 25°C ± 3°C

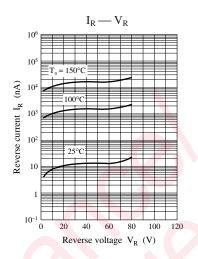
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$	1.50		1.2	V
Reverse voltage	V_R	$I_R = 100 \mu A$	80			V
Reverse current	I_R	V _R = 75 V			100	nA
Terminal capacitance	C _t	$V_R = 0 V, f = 1 MHz$			2	pF
Reverse recovery time *	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			3	ns
		$I_{rr} = 0.1 I_R$, $R_L = 100 \Omega$				

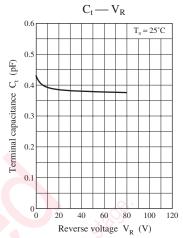
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring method for diodes.

- 2. Absolute frequency of input and output is 100 MHz.
- 3. *: t_{rr} measurement circuit









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